

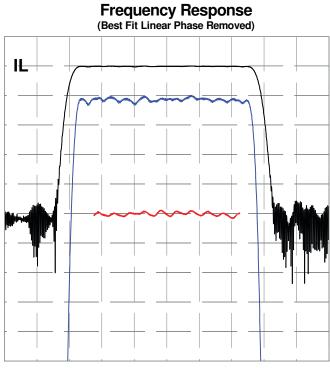
Specifications

Parameter	Symbol	Min	Typical	Max	Unit	
Center Frequency	Fo		304		MHz	
Bandwidth	В		50		MHz	
Delay	To	2.59	2.601	2.61	µsec	
Insertion Loss	IL		26	26.5	dB	
Amplitude Ripple			0.3	0.5	dB _{P-P}	
Phase Ripple			2.4	4	deg _{P-P}	
Spurious for $ t - T_0 > .9T_0$			-55	-54	dB	
Substrate Material	128YX-LN					

Notes

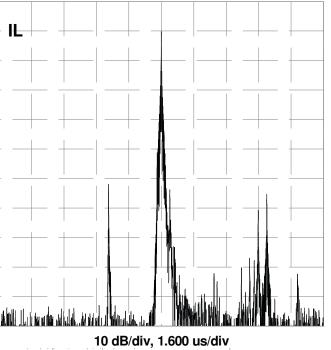
- 1. Center Frequency (F₀) and Bandwidth (B) are defined, not measured.
- 2. Insertion Loss is the minimum loss for $|f F_0| < .5B$
- 3. Ripple spec applies to the $|f F_0| < .4B$, and is doubled for $.4B < |f F_0| < .5B$
- 4. Specifications are at 22 °C only. Unit will operate undamaged from -54 °C to 125 °C with shifts dF₀ = $-x^*$ F₀, dT₀ = x^* T₀, where $x = 75E-6^*$ (temperature -22 °C)

Typical Performance



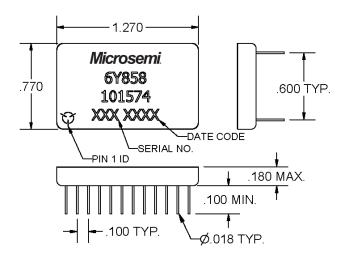
10 dB/div, 1 dB/div, 10 deg/div, 10.000 MHz/div

Impulse Response FFT(Frequency Response*Cos(0.5*PI*MIN(1,MAX(0,|f-F0|*2.0/50-1.0)))^2)

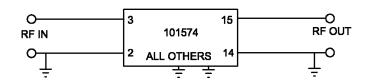




Package Outline



Matching





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